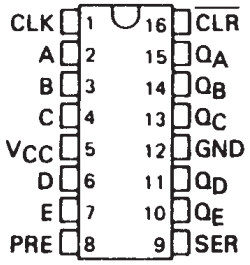
- N-Bit Serial-To-Parallel Converter
- N-Bit Parallel-To-Serial Converter
- N-Bit Storage Register

TYPE	TYPICAL PROPAGATION DELAY TIME	TYPICAL POWER DISSIPATION
'96	25 ns	240 mW
'LS96	25 ns	60 mW

SN5496, SN54LS96 . . . J OR W PACKAGE
SN7496 . . . N PACKAGE
SN74LS96 . . . D OR N PACKAGE
(TOP VIEW)



description

These shift registers consist of five R-S master-slave flip-flops connected to perform parallel-to-serial or serial-to-parallel conversion of binary data. Since both inputs and outputs for all flip-flops are accessible, parallel-in/parallel-out or serial-in/serial-out operation may be performed.

All flip-flops are simultaneously set to a low output level by applying a low-level voltage to the clear input while the preset is inactive (low). Clearing is independent of the level of the clock input.

The register may be parallel loaded by using the clear input in conjunction with the preset inputs. After clearing all stages to low output levels, data to be loaded is applied to the individual preset inputs (A, B, C, D, and E) and a high-level load pulse is applied to the preset enable input. Presetting like clearing is independent of the level of the clock input.

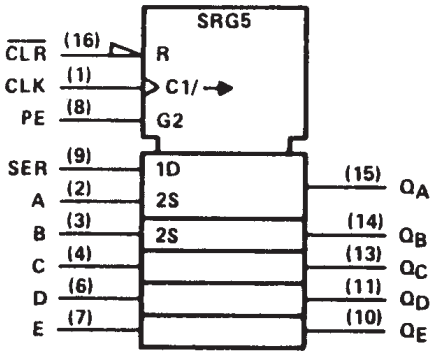
Transfer of information to the outputs occurs on the positive-going edge of the clock pulse. The proper information must be set up at the R-S inputs of each flip-flop prior to the rising edge of the clock input waveform. The serial input provides this information to the first flip-flop, while the outputs of the subsequent flip-flops provide information for the remaining R-S inputs. The clear input must be high and the preset or preset enable inputs must be low when clocking occurs.

FUNCTION TABLE

INPUTS									OUTPUTS				
$\overline{CLEAR}$	PRESET ENABLE	PRESET A	B	C	D	E	CLOCK	SERIAL	Q_A	Q_B	Q_C	Q_D	Q_D
L	L	X	X	X	X	X	X	X	L	L	L	L	L
L	X	L	L	L	L	L	X	X	L	L	L	L	L
H	H	H	H	H	H	H	X	X	H	H	H	H	H
H	H	L	L	L	L	L	L	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}
H	H	H	L	H	L	H	L	X	H	Q_{B0}	H	Q_{D0}	H
H	L	X	X	X	X	X	L	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}
H	L	X	X	X	X	X	↑	H	H	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}
H	L	X	X	X	X	X	↑	L	L	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}

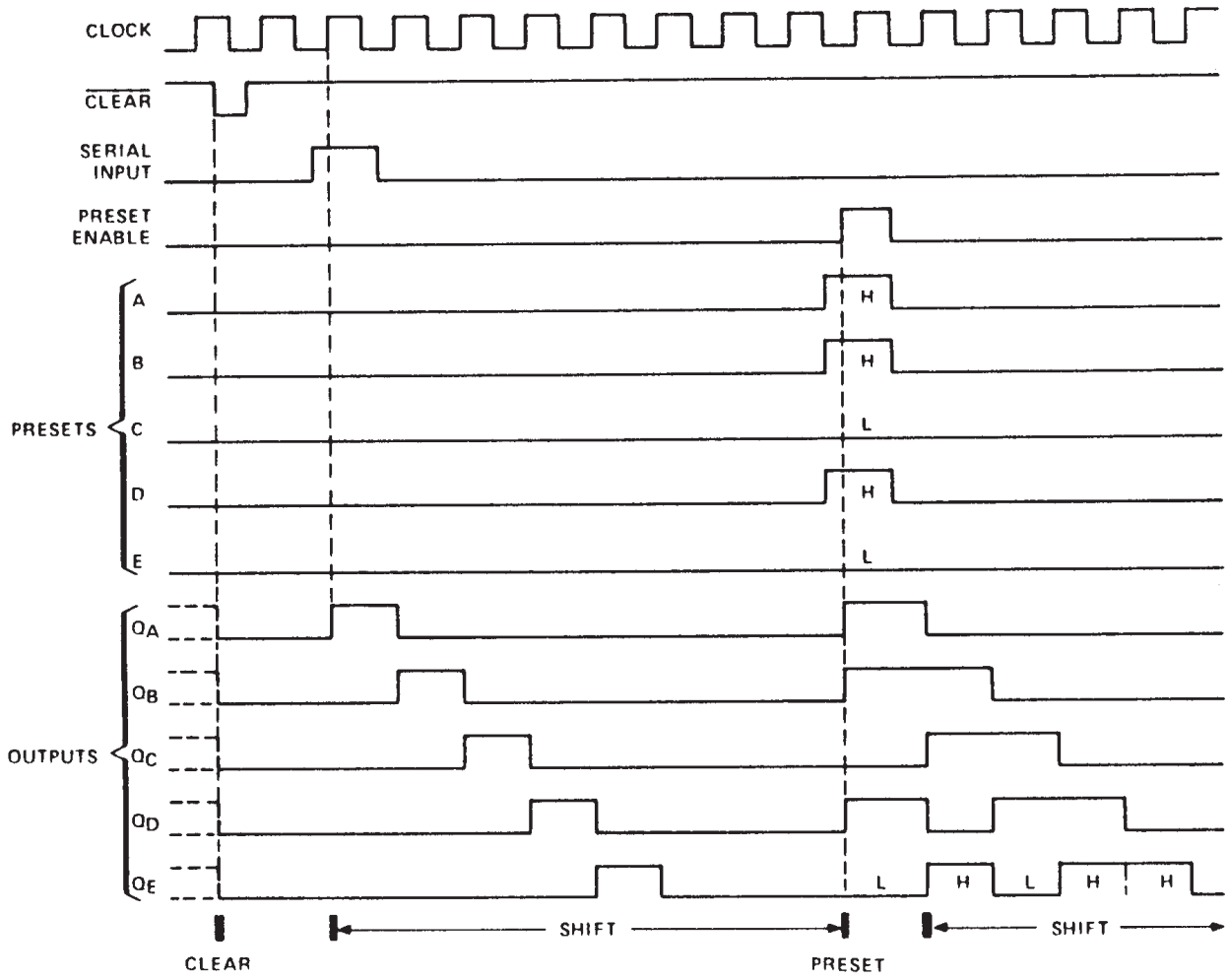
H = high level (steady state), L = low level (steady state)
X = irrelevant (any input, including transistion)
↑ = transistion from low to high level
Q_{A0}, Q_{B0}, etc = the level of Q_A, Q_B, etc, respectively before the indicated steady-state input conditions were established.
Q_{An}, Q_{Bn}, etc = the level of Q_A, Q_B, etc, respectively before the most recent ↑ transistion of the clock.

logic symbol†

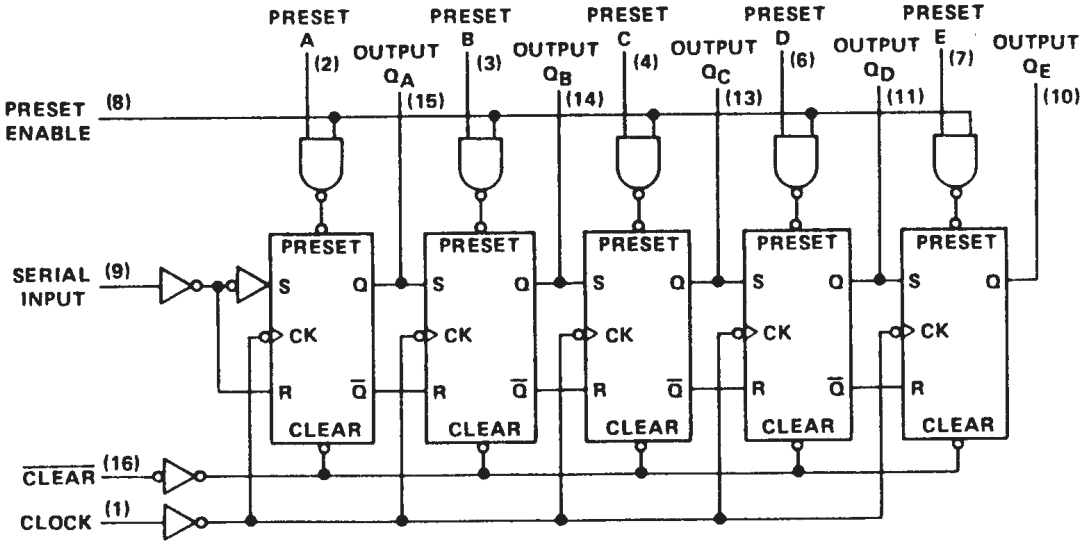


†This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

typical clear, shift, preset, and shift sequences



logic diagram (positive logic)



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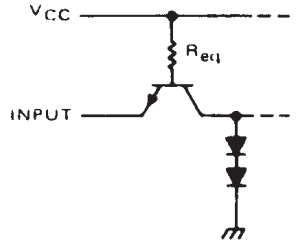
schematics of inputs and outputs

'96

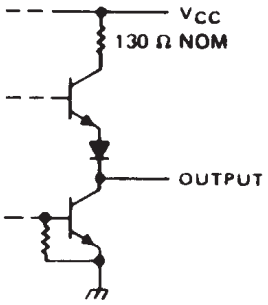
EQUIVALENT OF EACH INPUT



INPUT	R_{eq} NOM
Preset enable	800 Ω
All others	4 kΩ

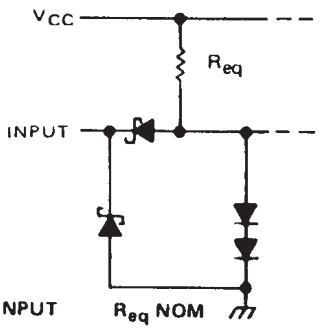
'96

TYPICAL OF ALL OUTPUTS



'LS96

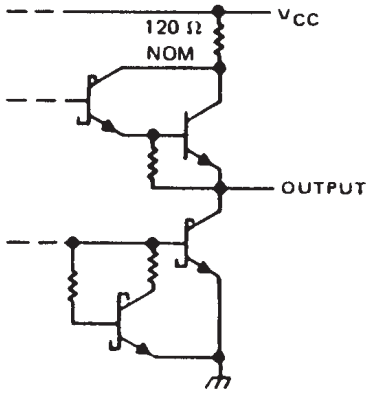
EQUIVALENT OF EACH INPUT



INPUT	R_{eq} NOM
Serial	25 kΩ
Clock, Clear	17 kΩ
Preset enable	3.4 kΩ

'LS96

TYPICAL OF ALL OUTPUTS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage (see Note 2): '96 . . . . . 5.5 V
'LS96 . . . . . 7 V
Operating free-air temperature: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values are with respect to network ground terminal.
2. Input voltage must be zero or positive with respect to network ground terminal.

recommended operating conditions

	SN5496			SN7496			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−400			−400	μA
Low-level output current, I_{OL}			16			16	mA
Clock frequency, f_{clock}	0		10	0		10	MHz
Width of clock input pulse, $t_{w(clock)}$	35			35			ns
Width of preset and clear input pulse, t_w	30			30			ns
Serial input setup time, t_{su} (see Figure 1)	30			30			ns
Serial input hold time, t_h (see Figure 1)	0			0			ns
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN5496			SN7496			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.8			0.8	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −400 μA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current	any input except preset enable	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
		preset enable				200			200	
I_{IL}	Low-level input current	any input except preset enable	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
		preset enable				−8			−8	
I_{OS}	Short-circuit output current§		V_{CC} = MAX	−20		−57	−18		−57	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 3		48	68		48	79	mA

†For conditions shown at MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.
NOTE 3: I_{CC} is measured with the clear input grounded and all other inputs and outputs open.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output from clock	C_L = 15 pF, R_L = 400 Ω, See Figure 1		25	40	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			25	40	ns
t_{PLH}	Propagation delay time, low-to-high-level output from preset or preset enable			28	35	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clear				55	ns

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recommended operating conditions

	SN54LS96			SN74LS96			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−400			−400	μA
Low-level output current, I_{OL}			4			8	mA
Clock frequency, f_{clock}	0		25	0		25	MHz
Width of clock input pulse, $t_{w(clock)}$	20			20			ns
Width of preset and clear input pulse, t_w	30			30			ns
Serial input setup time, t_{setup} (see Figure 1)	30			30			ns
Serial input hold time, t_{hold} (see Figure 1)	0			0			ns
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

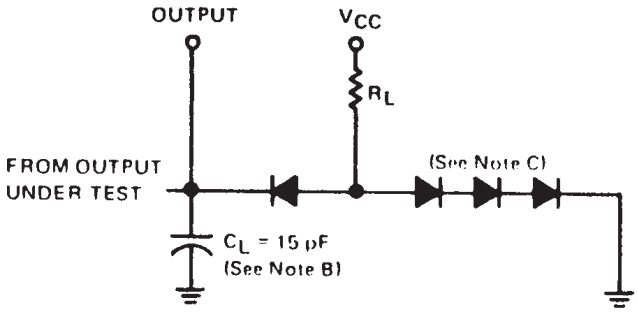
PARAMETER		TEST CONDITIONS†		SN54LS96			SN74LS96			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH} High-level input voltage				2			2			V
V_{IL} Low-level input voltage						0.7			0.8	V
V_{IK} Input clamp voltage		V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH} High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max, I_{OH} = −400 μA		2.5	3.5		2.7	3.5		V
V_{OL} Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 8 mA					0.35	0.5	
I_I Input current at maximum input voltage	Preset enable	V_{CC} = MAX, V_I = 7 V				0.5			0.5	mA
	All others					0.1			0.1	
I_{IH} High-level input current	Preset enable	V_{CC} = MAX, V_I = 2.7 V				100			100	μA
	All others					20			20	
I_{IL} Low-level input current	Preset enable	V_{CC} = MAX, V_I = 0.4 V				−2			−2	mA
	All others					−0.4			−0.4	
I_{OS} Short-circuit output current§		V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CC} Supply current		V_{CC} = MAX, See Note 3			12	20		12	20	mA

†For conditions shown at MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
NOTE 3: I_{CC} is measured with the clear input grounded and all other inputs and outputs open.

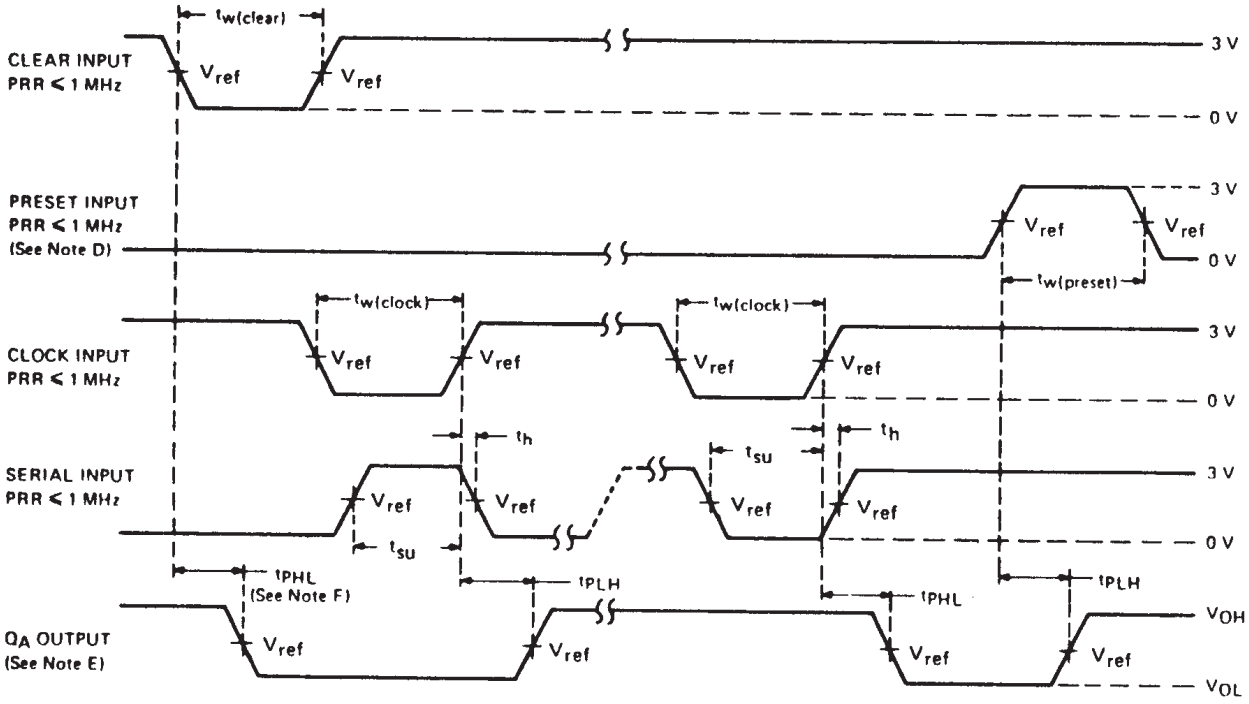
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output from clock	C_L = 15 pF, R_L = 2 kΩ, See Figure 1		25	40	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clock			25	40	ns
t_{PLH}	Propagation delay time, low-to-high-level output from preset or preset enable			28	35	ns
t_{PHL}	Propagation delay time, high-to-low-level output from clear				55	ns

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT



VOLTAGE WAVEFORMS

NOTES: A. Input pulses are supplied by pulse generators having the following characteristics: duty cycle ≤ 50%, Z_{out} ≈ 50 Ω; for '96, t_r ≤ 10 ns, t_f ≤ 10 ns, and for 'LS96 t_r = 15 ns, t_f = 6 ns.

B. C_L includes probe and jig capacitance.

C. All diodes are 1N3064 or equivalent.

D. Preset may be tested by applying a high-level voltage to the individual preset inputs and pulsing the preset enable or by applying a high-level voltage to the preset enable and pulsing the individual preset inputs.

E. Q_A output is illustrated. Relationship of serial input to other Q outputs is illustrated in the typical shift sequence.

F. Outputs are set to the high level prior to the measurement of t_{PHL} from the clear input.

G. For '96, V_{ref} = 1.5 V; for 'LS96 V_{ref} = 1.3 V.

FIGURE 1–SWITCHING TIMES

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
SN5496J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	Samples Not Available
SN7496N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	Samples Not Available
SN74LS96D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	Samples Not Available
SN74LS96DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	Samples Not Available
SN74LS96J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	Samples Not Available
SN74LS96N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	Samples Not Available
SN74LS96N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	Samples Not Available
SNJ5496J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	Samples Not Available
SNJ5496W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	Samples Not Available

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

OTHER QUALIFIED VERSIONS OF SN5496, SN7496 :

- Catalog: SN7496
- Military: SN5496

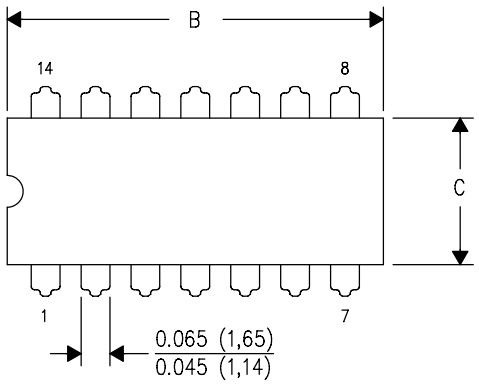
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

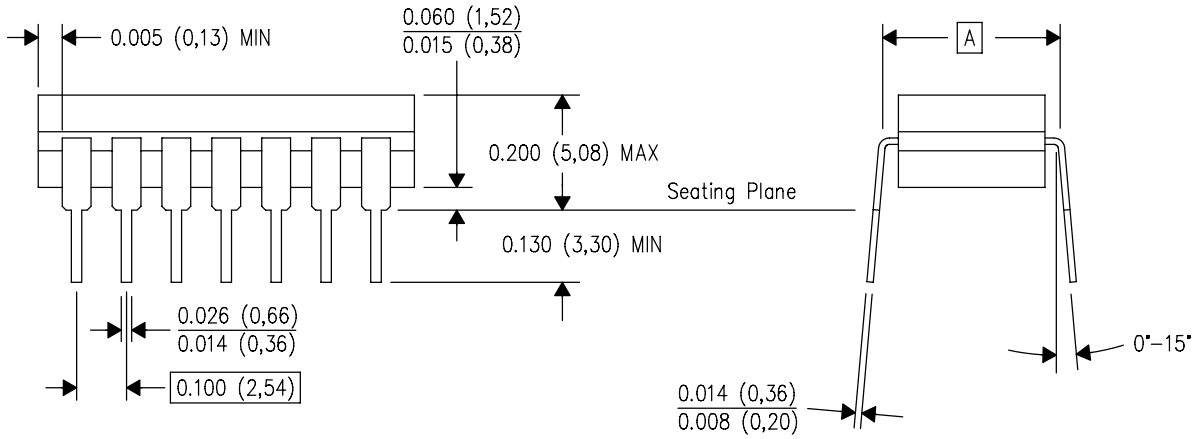
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



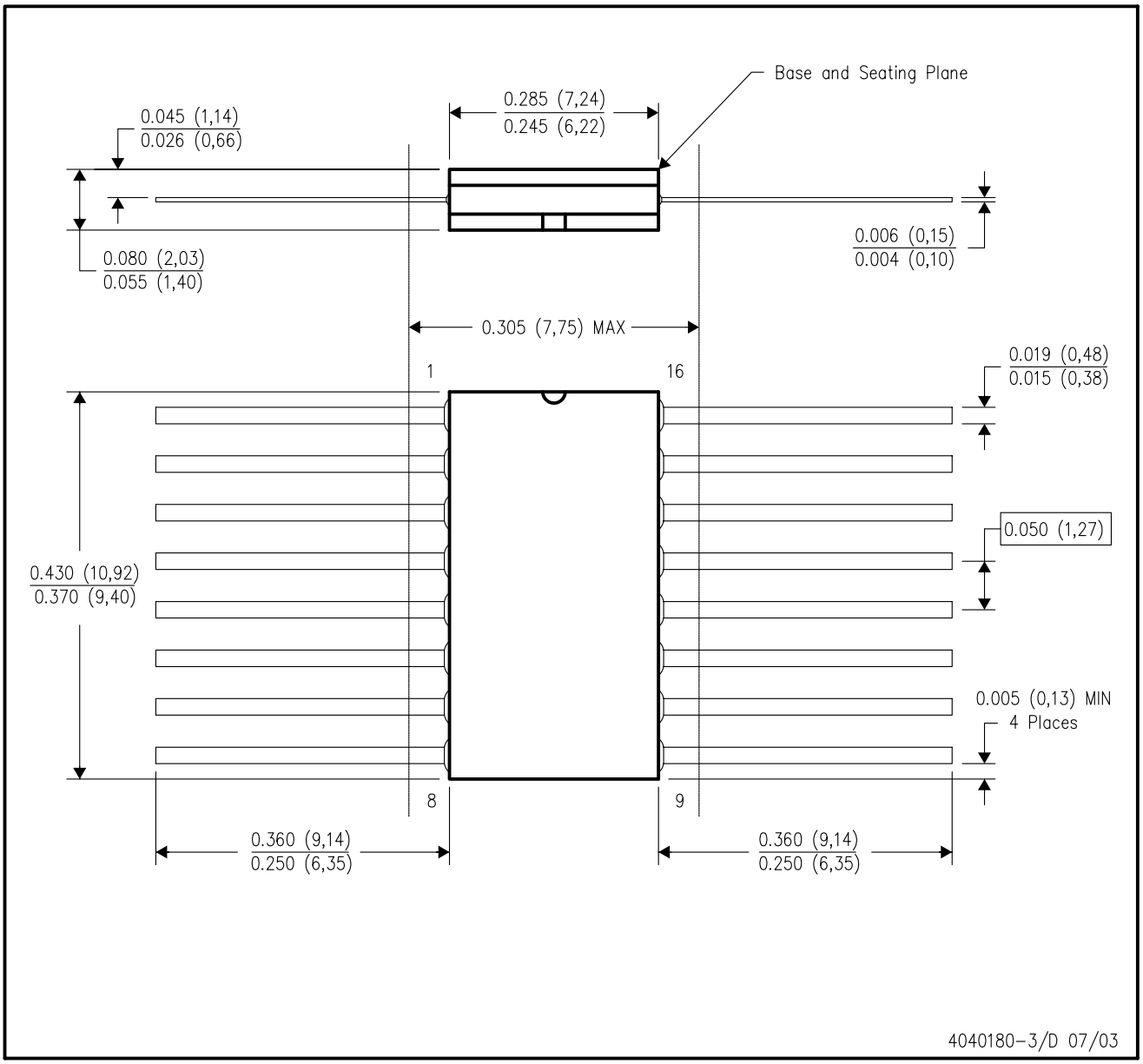
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

W (R–GDFP–F16) CERAMIC DUAL FLATPACK

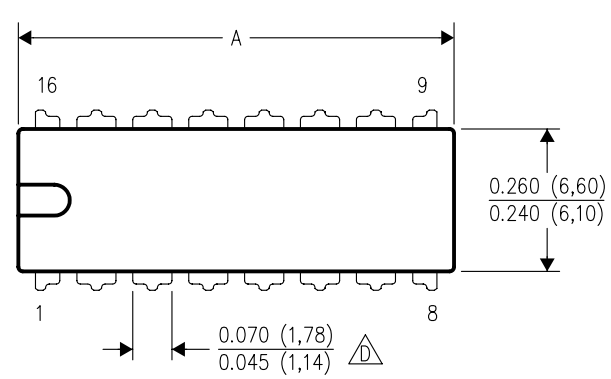


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F16 and JEDEC MO–092AC

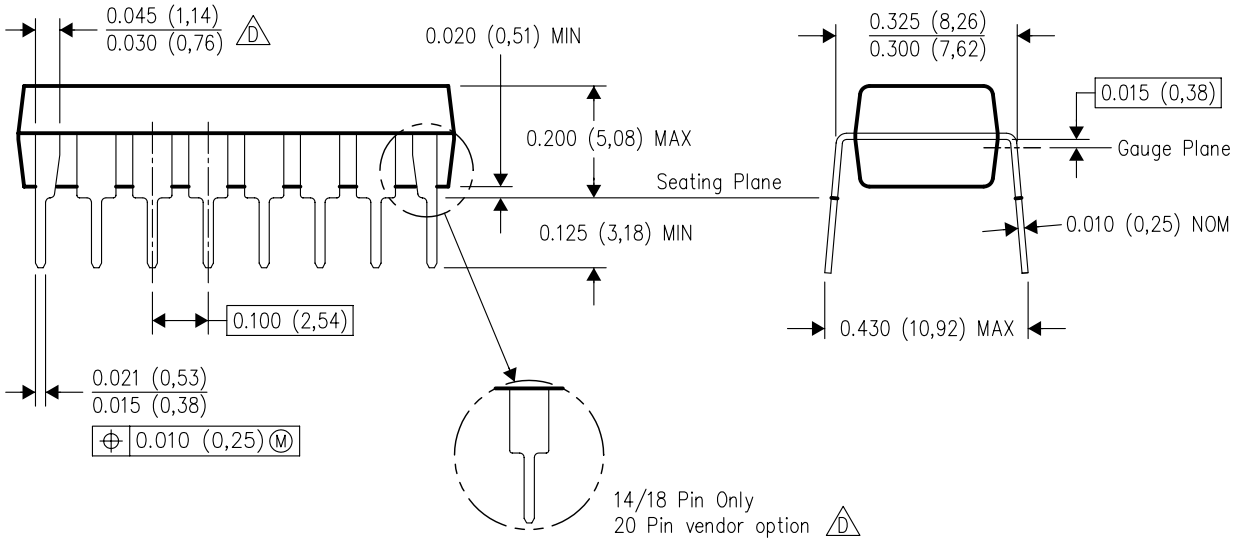
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



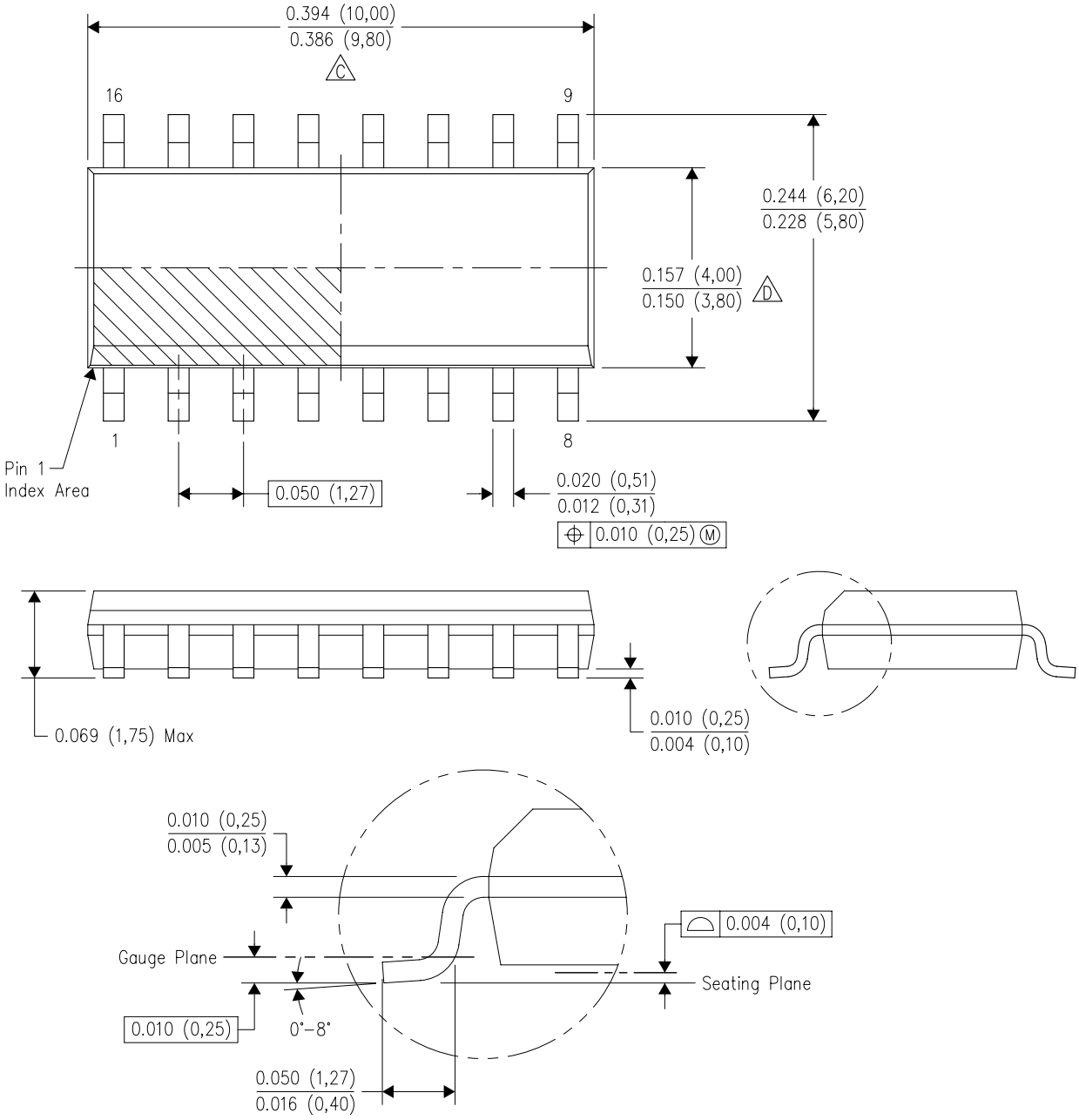
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G16) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AC.

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